

PLL frequency synthesizer for tuners

BU2615S / BU2615FS

The BU2615 PLL frequency synthesizers work up through the FM band. Featuring low radiation noise, low power consumption, and highly sensitive built-in RF amps, they support an IF count function.

●Applications

Tuners (Mini components, radio cassette players, radio equipment, etc.)

●Features

- 1) Built-in high-speed prescaler can divide 130MHzVCO.
- 2) Basic oscillation of 75kHz keeps unnecessary radiation noise to a low level.
- 3) Low current dissipation (during operation: 4mA, PLL OFF: 100 μ A)
- 4) In addition to the standard FM and AM, also offers the following 7 frequencies: 25kHz, 12.5kHz, 6.25kHz, 3.125kHz, 5kHz, 3kHz, and 1kHz.
- 5) Counter for measurement of intermediate frequencies.
- 6) Unlock detection
- 7) Seven output ports (open drain).
The BU2614, with three output ports, is also available.
- 8) Serial data input (CE, CK, DA)

●Absolute maximum ratings (Ta = 25°C)

Parameter		Symbol	Limits	Unit	Conditions
Power supply voltage		V _{DD}	-0.3~+7.0	V	V _{DD1} , V _{DD2}
Maximum input voltage 1		V _{IN1}	-0.3~+7.0	V	CE, CK, DA
Maximum input voltage 2		V _{IN2}	-0.3~V _{DD} +0.3	V	XIN, FMIN, AMIN, IFIN
Maximum output voltage 1		V _{OUT1}	-0.3~+10.0	V	P0, P1, P2, P3, P4, P6, CD
Maximum output voltage 2		V _{OUT2}	-0.3~V _{DD} +0.3	V	PD1, PD2, P5, XOUT
Maximum output current		I _{OUT}	0~+3.0	mA	P0, P1, P2, P3, P4, P6, CD
Power dissipation	BU2615	Pd	600*1	mW	
	BU2615FS		450*2		
Operating temperature		T _{opr}	-10~+75	°C	
Storage temperature		T _{stg}	-55~+125	°C	

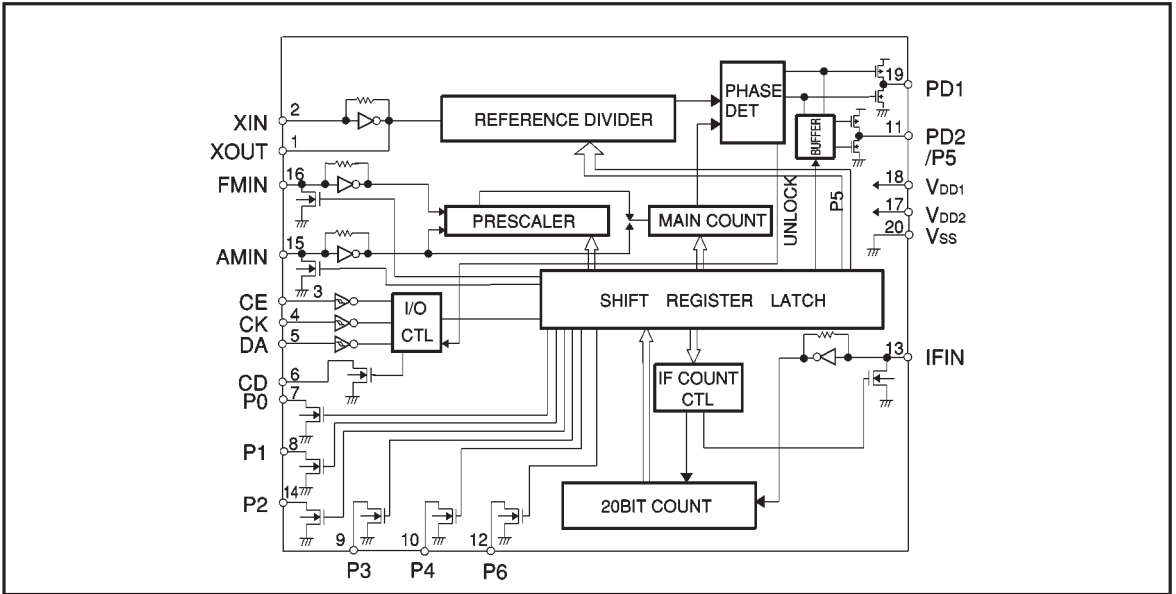
*1 Reduced by 6.0mW for each increase in Ta of 1°C over 25°C.

*2 Reduced by 4.5mW for each increase in Ta of 1°C over 25°C.

●Recommended operating power supply voltage

Parameter	Symbol	Limits	Unit
Power supply voltage	V _{DD1}	2.7~6.0	V
	V _{DD2}	4.0~6.0	V

● Block diagram



● Pin assignments

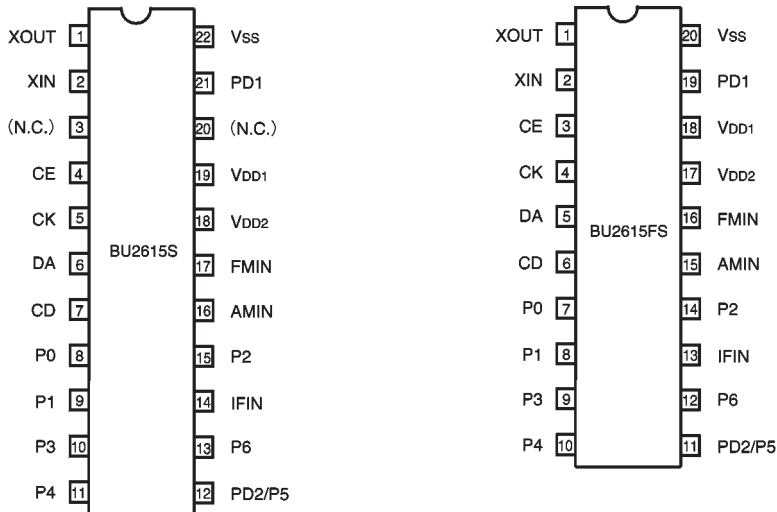


Fig.1 Pin assignments

● Pin descriptions

Pin No.		Symbol	Pin name	Function	I / O
BU2615S	BU2615FS				
1	1	XOUT	Crystal oscillation	For generation of standard frequency and internal clock. Connected to 75 kHz crystal resonator.	OUT
2	2	XIN			IN
4	3	CE	Chip enable	When CE is H, DA is synchronous with the rise of CK and read to the internal shift register. DA is then latched at the timing of the fall of CE. Also, output data is output from the CD terminal synchronous to the rise of CK.	IN
5	4	DA	Serial data		
6	5	CK	Clock signal		
7	6	CD	Count data	Frequency data and unlock data are output.	Nch open drain
8	7	P0	Output port	Controlled on the basis of input data. P5/PD2 can be switched between output port and phase comparison output on the basis of input data.	
9	8	P1			
10	9	P3			
11	10	P4			
12	11	P5/PD2			
13	12	P6		CMOS/3-state	
14	13	IFIN	IF input	Input for frequency measurement.	IN
15	14	P2	Output port	Controlled on the basis of input data.	Nch open drain
16	15	AMIN	AM input	Local input for AM	IN
17	16	FMIN	FM input	Local input for FM	IN
18	17	V _{DD2}	Power supply 2	4.0V to 6.0V applied for high-speed circuit power supply.	—
19	18	V _{DD1}	Power supply 1	Power supply for logic. 2.7V to 6.0V	—
21	19	PD1	Phase comparison output	High level when value obtained by dividing local output is higher than standard frequency. Low level when value is lower. High impedance when value is same.	3-state
22	20	V _{SS}	GROUND		—
3.20	—	N.C.	N.C.	No internal connection.	—

●Electrical characteristics (unless otherwise noted, Ta = 25°C, V_{DD1} = V_{DD2} = 5.0V)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Power supply current 1	I _{DD1}	—	5.0	10.0	mA	F _{MIN} =130MHz, 100mV _{rms} 17-pin current
Power supply current 2	I _{DD2}	—	100	150	μA	18-pin current
Quiescent current	I _{DD3}	—	150	300	μA	No input, PLL = OFF 17-pin current
Input high level voltage	V _{IH}	4.0	—	—	V	CE, CK, DA terminals
Input low level voltage	V _{IL}	—	—	1.0	V	CE, CK, DA terminals
Input high level current 1	I _{IH1}	—	—	1.0	μA	CE, CK, DA terminals V _{IN} =V _{DD}
Input high level current 2	I _{IH2}	—	0.3	—	μA	XIN terminal V _{IN} =V _{DD}
Input high level current 3	I _{IH3}	—	6.0	—	μA	F _{MIN} , A _{MIN} , I _{FIN} terminals V _{IN} =V _{DD}
Input low level current 1	I _{IL1}	-1.0	—	—	μA	CE, CK, DA terminals V _{IN} =V _{SS}
Input low level current 2	I _{IL2}	—	-0.3	—	μA	XIN terminal V _{IN} =V _{SS}
Input low level current 3	I _{IL3}	—	-6.0	—	μA	F _{MIN} , A _{MIN} , I _{FIN} terminals V _{IN} =V _{SS}
Output low level voltage 1	V _{OL1}	—	0.2	0.5	V	P0, P1, P2, P3, P4, P6, CD I _O =1.0mA
Off level leakage current 1	I _{OFF1}	—	—	1.0	μA	P0, P1, P2, P3, P4, P6, CD V _O =10V
Output low level voltage 2	V _{OL2}	—	0.1	0.5	V	F _{MIN} , A _{MIN} , I _{FIN} terminals I _{OUT} =0.1mA
Output high level voltage	V _{OH}	V _{DD} -1.0	V _{DD} -0.3	—	V	PD1, PD2, P5 I _{OUT} =-1.0mA
Output low level voltage	V _{OL}	—	0.2	1.0	V	PD1, PD2, P5 I _{OUT} =1.0mA
Off level leakage current 2	I _{OFF2}	—	—	100	nA	PD1, PD2 V _{OUT} =V _{DD}
Off level leakage current 3	I _{OFF3}	-100	—	—	nA	PD1, PD2 V _{OUT} =V _{SS}
Internal feedback resistor 1	R _{F1}	—	10	—	MΩ	XIN
Internal feedback resistor 2	R _{F2}	—	500	—	kΩ	F _{MIN} , A _{MIN} , I _{FIN} terminals
Input frequency 1	F _{IN1}	10	75	160	kHz	XIN, sine wave, C coupling
Input frequency 2	F _{IN2}	10	—	130	MHz	F _{MIN} , sine wave, C coupling V _{IN} = 50 mV _{rms}
Input frequency 3	F _{IN3}	0.4	—	30	MHz	A _{MIN1} , sine wave, C coupling V _{IN} = 70 mV _{rms}
Input frequency 4	F _{IN4}	0.4	—	16	MHz	I _{FIN} , sine wave, C coupling V _{IN} = 70 mV _{rms}
Maximum input amplitude	F _{INMAX}	—	—	1.5	V _{rms}	XIN, F _{MIN} , A _{MIN} , I _{FIN} , sine wave, C coupling
Minimum pulse amplitude	TW	—	1.0	—	μs	CK, DA
Input rise time	TR	—	—	500	ns	CE, CK, DA
Input fall time	TF	—	—	500	ns	CE, CK, DA

●Explanation of the data

(1) Division data: For D₀ through D₁₅ (When S = 1, use D₄ through D₁₅.)

D ₀	D ₁	D ₂	D ₃	D ₄	D ₅	D ₆	D ₇	D ₈	D ₉	D ₁₀	D ₁₁	D ₁₂	D ₁₃	D ₁₄	D ₁₅
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Examples:

Divide ratio=1100(D) 1100(D)÷2=550(D)=226(H) S=0, PS=0 Divide ratio is double the set value.

0 1 1 0 | 0 1 0 0 | 0 1 0 0 | 0 0 0 0

Divide ratio=1107(D)=453(H) S=1, PS=1

1 1 0 0 | 1 0 1 0 | 0 0 1 0 | 0 0 0 0

Divide ratio=926(D)=39E(H) S=1, PS=0

× × × × | 0 1 1 1 | 1 0 0 1 | 1 1 0 0

(2) CT: Frequency measurement beginning data

1: Beginning of measurement

0: Internal counter is reset, IFIN is pulldown.

(3) Output port control data: P₀, P₁, P₂, P₃, P₄, P₅, P₆

1: Open drain output ON (P₅ is LO)

0: Open drain output OFF (P₅ is HI)

(4) R₀, R₁, R₂, standard frequency data

Data			Standard frequency
R ₀	R ₁	R ₂	
0	0	0	25kHz
0	0	1	12.5kHz
0	1	0	6.25kHz
0	1	1	5kHz
1	0	0	3.125kHz
1	0	1	3kHz
1	1	0	1kHz
1	1	1	※PLL OFF

※ FMIN = pulldown, AMIN = pulldown, PD = high impedance

(5) S: switch between FMIN and AMIN

0: FMIN 1: AMIN

(6) PS: If this bit is set to ON while AMIN is selected, swallow counter division is possible.

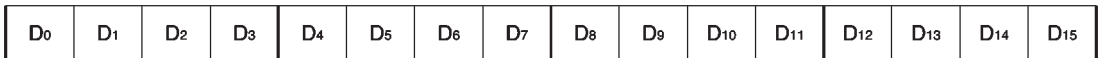
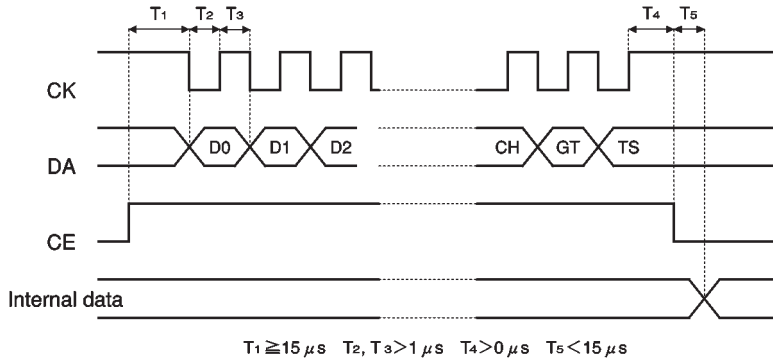
(7) CH: If this bit set to ON, output port P₅ goes to phase comparison output. 0: P₅ 1: PD₂

(8) GT: Frequency measurement time and unlock detection ON/OFF

CT	GT	Frequency measurement	Unlock detection	Data output
0	0	OFF	OFF	OK
0	1	OFF	ON	
1	0	ON gate time 16 ms	ON	
1	1	ON gate time 32 ms	ON	

(9) TS: Test data. Input(0).

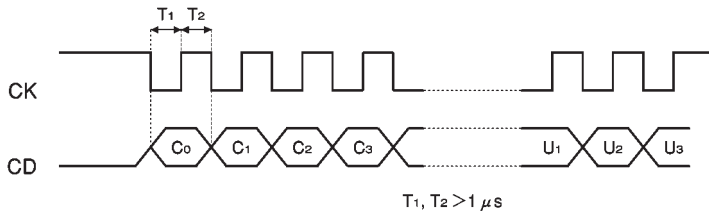
● Input data format



← Input done from D₀.



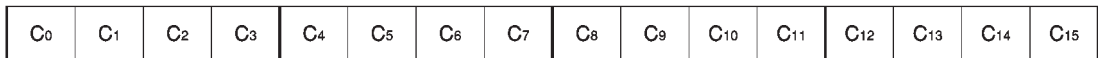
Output data format CE output is LO.



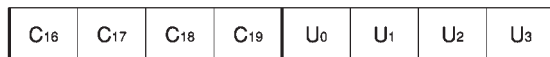
Output data includes pullup resistance.

Output data format

LSB



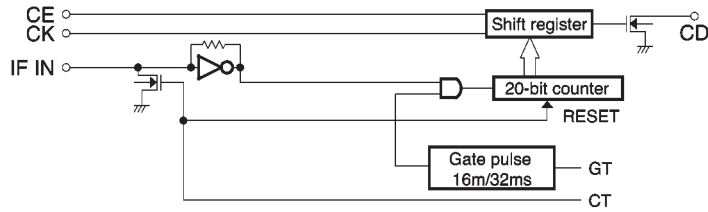
← Output done from C₀.



※ Data output only possible when CT = 1 or GT = 1.

● Frequency counter

(1) Structure



(2) How the frequency counter operates

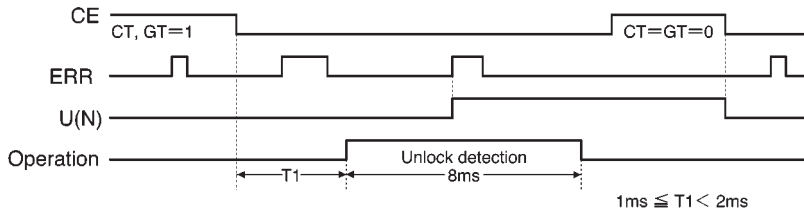
When control data CT equals 1, the 20-bit counter and the amp go into operation. When CT equals 0, input pull-down and the counter are reset. Measuring time (gate pulse) is selected (16ms/32ms) on the basis of control data GT. When control data CT equals 0, the counter is reset.

(3) Explanation of output data

D₀: LSB D₁₉: MSB

How the unlock detection circuit operates

When control data GT equals 1, or CT equals 1, the unlock detection circuit goes into operation for 8ms. When CT equals 1, the unlock detection circuit stops operating before the frequency counter gate pulse is emitted. When CT equals 0, or GT equals 0, the unlock detection circuit is reset.

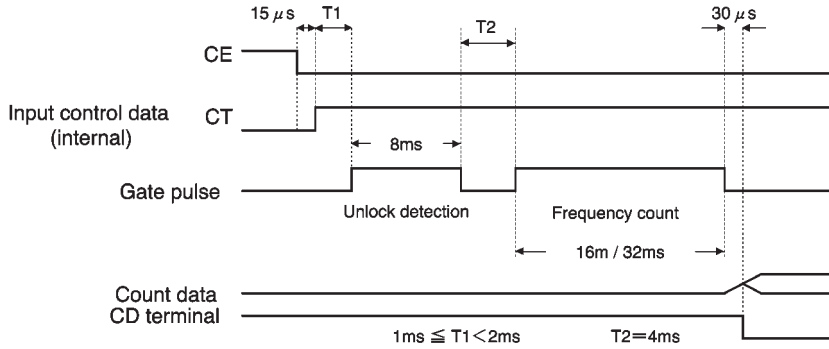


Explanation of output data

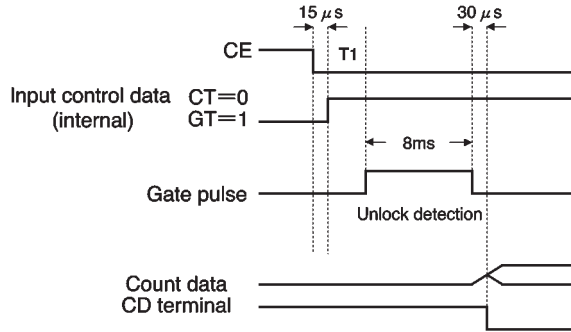
U0	U1	U2	U3				
0	0	0	0	<	ERR	<	7 μs
1	1	1	0	7 μs	<	ERR	< 13 μs
1	1	0	0	13 μs	<	ERR	< 26 μs
1	1	1	0	26 μs	<	ERR	< 54 μs
1	1	1	1	54 μs	<	ERR	<

●How the frequency counter and unlock detection circuit operate

(1) When CT = 1: Frequency count and unlock detection are carried out.

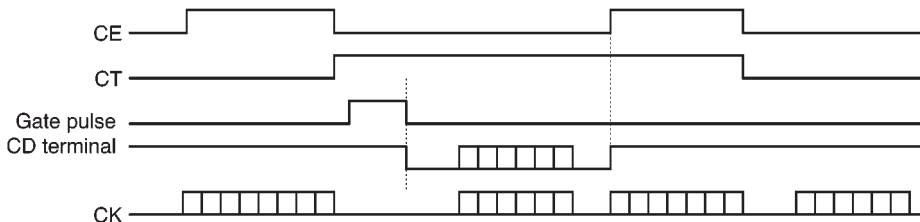


(2) When CT = 0 and GT = 1: Only unlock detection is carried out.



●Explanation of CD terminal

When frequency measurement or unlock detection is finished, the CD terminal goes to LO to indicate that the count and unlock detection have finished. It also synchronizes with CK to output counter data. When the next data is input, it goes to HI.



● External dimensions (Units: mm)

